

1 2 3 4 5 6 7 8

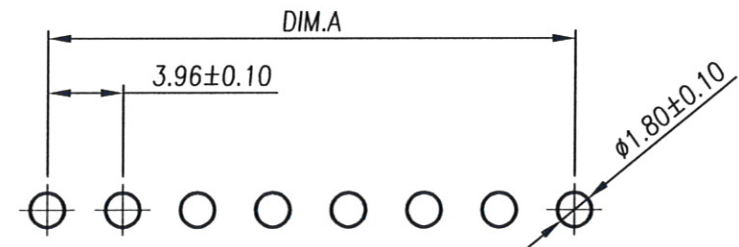
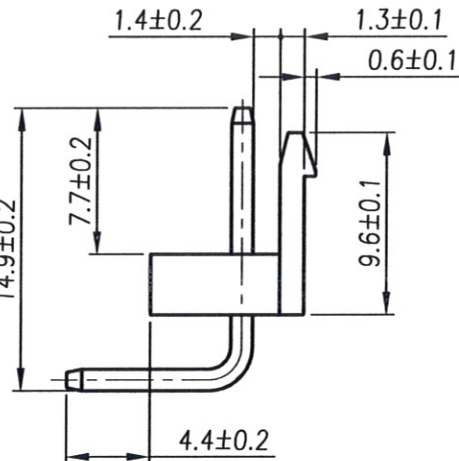
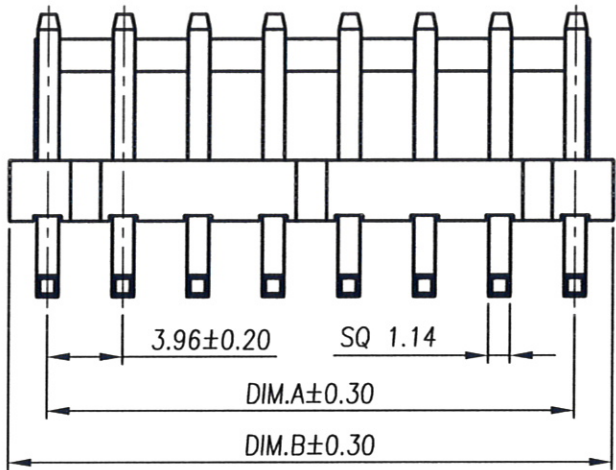
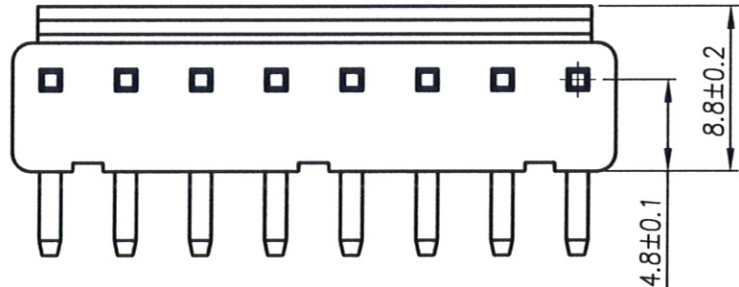


RoHS Compliant

REV	MODIFICATION	DATE	DRAW
A0	Release To Production	2008.12.11	Ricky
A1	Release To ECN20130208	2013.03.07	Seven

A
B
C
D
E
F

A
B
C
D
E
F



RECOMMENDED PCB LAYOUT
(Tolerance:±0.05)

Specification

- 1.Current Rating:7A
- 2.Voltage Rating:250V AC/DC
- 3.Contact Resistance:10mΩ Max.
- 4.Insulation Resistance:1000MΩ Min. At DC 500V
- 5.Dielectric Withstanding Voltage:1500 VAC/Minute
- 6.Operating Temperature:-25℃~+85℃

Material:

- 1.Housing:Thermoplastic UL94V-0
 - 2.Contact Pin:Copper Alloy SQ=1.14mm
- Finish:**
- 1.Housing:Natural
 - 2.Contact Pin:Bright Tin Plated Over Ni

Part No.: ADO2201 XX X 1 5 2

Number of Pin 02~14 Packing 5:Bag

Housing Material 1:NY66 UL94V-0 Natural Plating 1:Bright Tin Plated Over Ni
4:NY66+GF. UL94V-0 Natural

PIN	DIM.A	DIM.B	PIN	DIM.A	DIM.B
02	3.96	7.92	09	31.68	35.86
03	7.92	11.92	10	35.64	39.90
04	11.88	15.84	11	39.60	43.84
05	15.84	19.84	12	43.56	47.92
06	19.80	23.80	13	47.52	51.72
07	23.76	27.88	14	51.48	55.92
08	27.72	31.74			



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TOLERANCE UNLESS OTHERWISE SPECIFIED		PROJ.	TITLE: Wire To Board Wafer 3.96mm 90° DIP		
.x± 0.35	.x'± 2'	APR. Jay 20130227	PART NO. ADO2201XXX152		DWG NO. ADO2201XXX152
.xx± 0.25	.x'± 1'	CHK. Michelle 20130227	UNITS: mm	CUSTOMER DRAWING	
.xxx± 0.15	.xx'± 0.5'	DRA. Seven 20130227	SIZE: A4	SCALE 2.5:1	SHEET 1 / 1 REV A1 V

1 2 3 4 5 6 7 8